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ON Semiconductor®

FDD3860

N-Channel PowerTrench[®] MOSFET 100 V, 29 A, 36 m Ω

Features

- Max $r_{DS(on)}$ = 36 m Ω at V_{GS} = 10 V, I_D = 5.9 A
- High Performance Trench Technology for Extremely Low r_{DS(on)}
- 100% UIL Tested
- RoHS Compliant

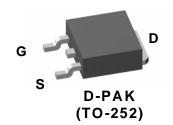


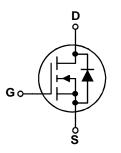
General Description

This N-Channel MOSFET is rugged gate version of ON Semiconductor's advanced Power Trench[®] process. This part is tailored for low $r_{DS(on)}$ and low Qg figure of merit, with avalanche ruggedness for a wide range of switching applications.

Applications

- DC-AC Conversion
- Synchronous Rectifier





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

| Symbol | Parameter | | | Ratings | Units | |
|-----------------------------------|--|---------------------------------|-----------|-------------|-------|--|
| V _{DS} | Drain to Source Voltage | | | 100 | V | |
| V _{GS} | Gate to Source Voltage | | | ±20 | V | |
| I _D | Drain Current -Continuous | $T_{C} = 25^{\circ}C$ | | 29 | | |
| | -Continuous | T _A = 25°C | (Note 1a) | 6.2 | A | |
| | -Pulsed | | | 60 | | |
| E _{AS} | Single Pulse Avalanche Energy | | (Note 3) | 121 | mJ | |
| P _D | Power Dissipation | $T_{\rm C} = 25^{\circ}{\rm C}$ | | 83 | W | |
| | Power Dissipation | T _A = 25°C | (Note 1a) | 3.75 | VV | |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | | -55 to +175 | °C | |

Thermal Characteristics

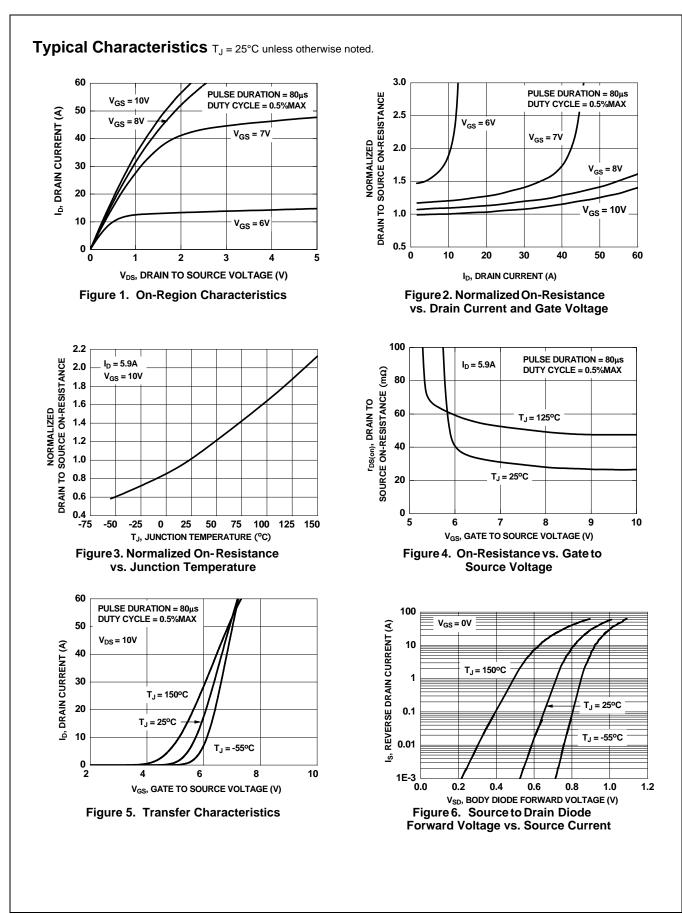
| R_{\thetaJC} | Thermal Resistance, Junction to Case | 1.8 | °C/W |
|---------------------|---|-----|-------|
| $R_{	ext{	heta}JA}$ | Thermal Resistance, Junction to Ambient (Note 1a) | 40 | C/ VV |

Package Marking and Ordering Information

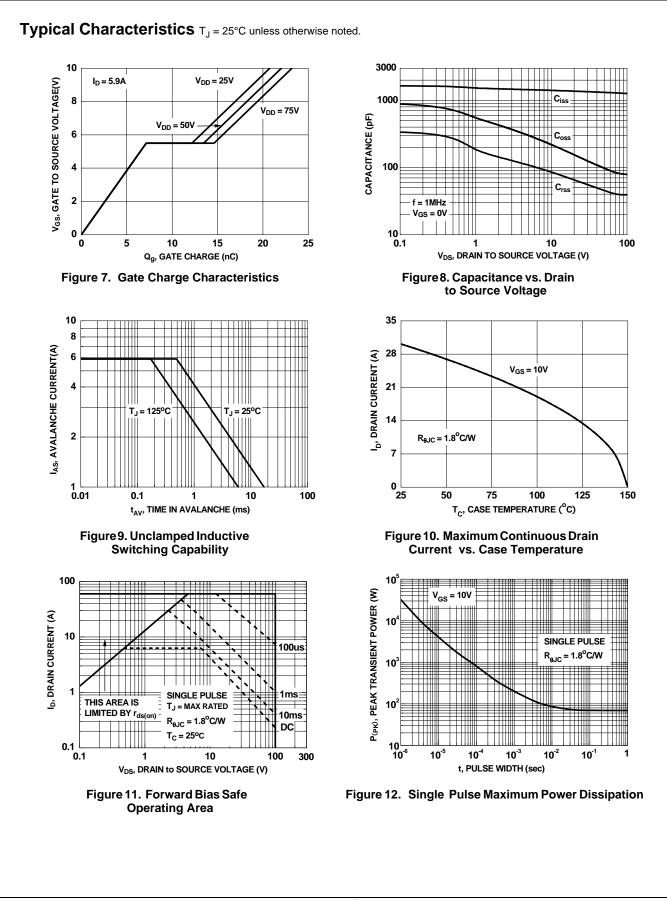
| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|---------|----------------|-----------|------------|------------|
| FDD3860 | FDD3860 | D-PAK (TO-252) | 13" | 16 mm | 2500 units |

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|--|--|---|------|------------|------|---------------------------------------|
| off Chara | acteristics | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | $I_{D} = 250 \mu A, V_{GS} = 0 V$ | 100 | | | V |
| ΔBV _{DSS} ΔT _{.1} | Breakdown Voltage Temperature Coefficient | $I_D = 250 \mu A$, referenced to 25°C | | 98 | | mV/°C |
| DSS | Zero Gate Voltage Drain Current | $V_{DS} = 80V, V_{GS} = 0V$ | | | 1 | μA |
| GSS | Gate to Source Leakage Current | $V_{GS} = \pm 20V, V_{DS} = 0V$ | | | ±100 | nA |
| | - | 65 / 55 | | | | |
| | Cate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_{D} = 250 \mu A$ | 2.5 | 3.8 | 4.5 | V |
| / _{GS(th)} | Gate to Source Threshold Voltage Gate to Source Threshold Voltage | $v_{GS} = v_{DS}, I_D = 250 \mu A$ | 2.0 | 3.0 | 4.5 | v |
| ∆V _{GS(th)} ∆TJ | Temperature Coefficient | $I_D = 250 \mu A$, referenced to $25^{\circ}C$ | | -11.4 | | mV/°C |
| r _{DS(on)} | Static Drain to Source On Resistance | V _{GS} = 10V, I _D = 5.9A | | 29 | 36 | mΩ |
| | | $V_{GS} = 10V, I_D = 5.9A, T_J = 125^{\circ}C$ | | 51 | 64 | |
| Ĵfs | Forward Transconductance | $V_{DS} = 10V, I_{D} = 5.9A$ | | 20 | | S |
| ynamic | Characteristics | | | | | |
| liss | Input Capacitance | | | 1310 | 1740 | pF |
| Soss | Output Capacitance | $V_{DS} = 50V, V_{GS} = 0V,$ f = 1MHz | | 100 | 130 | pF |
| Srss | Reverse Transfer Capacitance | | | 45 | 70 | pF |
| Rg | Gate Resistance | f = 1MHz | | 1.6 | | Ω |
| | g Characteristics | | | | | |
| | Turn-On Delay Time | | | 16 | 29 | ns |
| d(on) | Rise Time | V _{DD} = 50V, I _D = 5.9A, | | 10 | 23 | |
| r | | $-V_{GS} = 10V, R_{GEN} = 6\Omega$ | | - | | ns |
| d(off) | Turn-Off Delay Time | | | 24 | 39 | ns |
| f | Fall Time | | | 7 | 15 | ns |
| ζ ^g | Total Gate Charge at 10V | V _{DD} = 50V, I _D = 5.9A | | 22 | 31 | nC |
| 2 _{gs} | Gate to Source Charge | | | 7.1 | | nC |
| 2 _{gd} | Gate to Drain "Miller" Charge | | | 6.3 | | nC |
| Drain-Sou | urce Diode Characteristics | | | | | |
| / _{SD} | Source to Drain Diode Forward Voltage | $V_{GS} = 0V, I_{S} = 2.0A$ (Note 2) | | 0.7 | 1.2 | v |
| SD | Boarde to Brain Blode Torward Voltage | $V_{GS} = 0V, I_S = 5.9A$ (Note 2) | | 0.8 | 1.3 | , , , , , , , , , , , , , , , , , , , |
| rr | Reverse Recovery Time | L = 5.90 di/dt = 1000/us | | 34 | 55 | ns |
| ک _{rr} | Reverse Recovery Charge | — I _F = 5.9A, di/dt = 100A/μs | | 40 | 64 | nC |
| R _{6JC} is guara | um of the junction-to-case and case-to-ambient thermal resi anteed by design while $R_{0,JA}$ is determined by the user's box a) 40° C/W when module $1 \text{ in}^2 \text{ pad of } 2 \text{ oz } 10^{\circ}$ a) 40° C/W when module $1 \text{ in}^2 \text{ pad of } 2 \text{ oz } 10^{\circ}$ because values Width < 300μ s, Duty cycle < 2.0%. 25° C, L = 3mH, I _{AS} = 9A, V _{DD} = 100V, V _{GS} = 10V. | punted on a b) 96 | | en mounted | | |
| | | | | | | |

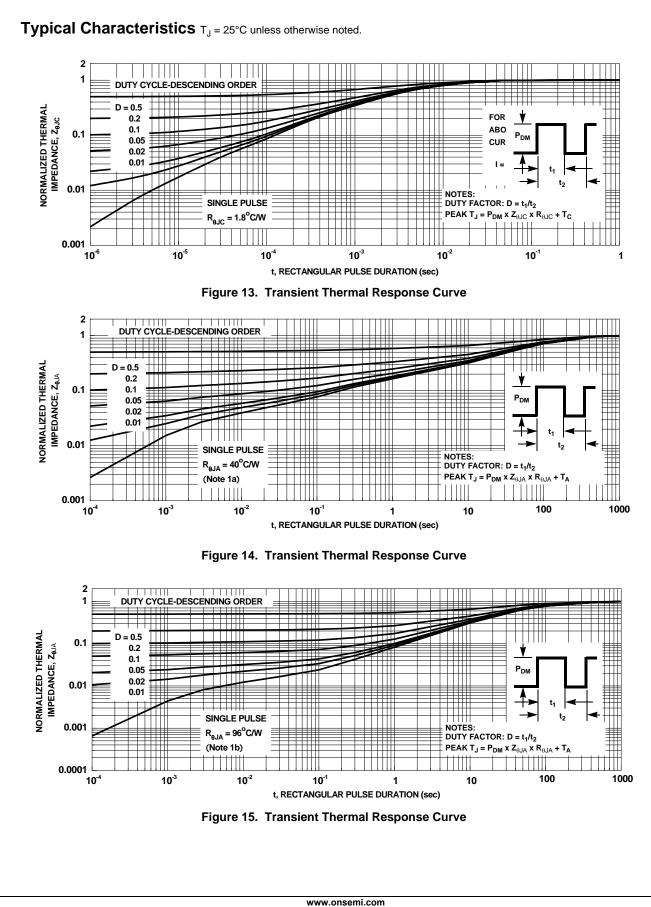
Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted.



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FDD3860 N-Channel PowerTrench[®] MOSFET

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